

INTERNATIONAL STANDARD

NORME INTERNATIONALE

**Field Device Integration (FDI) –
Part 109-1: Profiles – HART® and WirelessHART®**

**Intégration des appareils de terrain (FDI) –
Partie 109-1: Profils – HART® et WirelessHART®**



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CONTENTS

FOREWORD.....	4
INTRODUCTION.....	6
1 Scope.....	7
2 Normative references	7
3 Terms, definitions, abbreviated terms and acronyms	7
3.1 Terms and definitions.....	7
3.2 Abbreviated terms and acronyms	7
4 Conventions	8
4.1 EDDL syntax.....	8
4.2 XML syntax.....	8
4.3 Capitalizations	8
5 Profile for CP 9/1 (HART®) or CP 9/2 (WirelessHART®)	9
5.1 General.....	9
5.2 Catalog profile	9
5.2.1 Protocol support file.....	9
5.2.2 CommunicationProfile definition.....	9
5.2.3 Profile device.....	9
5.2.4 Protocol version information	9
5.3 Associating a Package with a CP 9/1 device	10
5.3.1 Device type identification mapping.....	10
5.3.2 Device type revision mapping	10
5.4 Information Model mapping	10
5.4.1 ProtocolType definition	10
5.4.2 DeviceType mapping	11
5.4.3 FunctionalGroup Identification definition	11
5.5 Topology elements.....	11
5.5.1 ConnectionPoint definition	11
5.5.2 Communication Device definition	17
5.5.3 Communication service provider definition	18
5.5.4 Network definition.....	19
5.6 Methods.....	19
5.6.1 Methods for FDI Communication Servers.....	19
5.6.2 Methods for Gateways	23
Annex A (normative) Topology scan schema.....	31
A.1 General.....	31
A.2 IdentificationType	31
A.3 AddressTypeTP	33
A.4 AddressTypeIP	34
A.5 AddressTypeTDMA.....	34
A.6 AddressType.....	35
A.7 ConnectionPointType.....	36
A.8 NetworkType.....	36
A.9 Network	37
Annex B (normative) Transfer service parameters.....	38
B.1 General.....	38

B.2	receiveData	38
B.3	sendData	38
B.4	TransferResultDataT	38
B.5	TransferSendDataT	39
	Bibliography	40
	Table 1 – CommunicationProfile definition	9
	Table 2 – Catalog values for profile devices	9
	Table 3 – Protocol Version Information	10
	Table 4 – Device type catalog mapping	10
	Table 5 – ProtocolType HART definition	10
	Table 6 – Inherited DeviceType Property mapping	11
	Table 7 – Identification parameters	11
	Table 8 – ConnectionPointType HART_TP definition	12
	Table 9 – ConnectionPointType HART_IP Definition	15
	Table 10 – ConnectionPointType HART_TDMA Definition	16
	Table 11 – Method Connect arguments	20
	Table 12 – Method Disconnect arguments	20
	Table 13 – Method Transfer arguments	21
	Table 14 – Method GetPublishedData arguments	22
	Table 15 – Method SetAddress arguments	22
	Table 16 – Method Connect arguments	24
	Table 17 – Method Disconnect arguments	24
	Table 18 – Method Transfer arguments	25
	Table 19 – Method GetPublishedData arguments	27
	Table 20 – Method SetAddress arguments	28
	Table A.1 – Attributes of IdentificationT	33
	Table A.2 – Elements of AddressTypeTP	33
	Table A.3 – Elements of AddressTypeIP	34
	Table A.4 – Elements of AddressTypeTDMA	35
	Table A.5 – Elements of AddressT	35
	Table A.6 – Elements of ConnectionPointT	36
	Table A.7 – Elements of NetworkT	36
	Table B.1 – Attributes of TransferResultDataT	38
	Table B.2 – Attributes of TransferSendDataT	39

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FIELD DEVICE INTEGRATION (FDI) –

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HART® and WirelessHART®

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The text of this standard is based on the following documents:

CDV	Report on voting
65E/356/CDV	65E/419/RVC

Full information on the voting for the approval of this standard can be found in the report on voting indicated in the above table.

This publication has been drafted in accordance with the ISO/IEC Directives, Part 2.

A list of all parts in the IEC 62769 series, published under the general title *Field Device Integration (FDI)*, can be found on the IEC website.

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FIELD DEVICE INTEGRATION (FDI) –

Part 109-1: Profiles – HART® and WirelessHART®

1 Scope

This part of IEC 62769 specifies an FDI profile of IEC 62769 for IEC 61784-1_CP 9/1 (HART®)¹ and IEC 61784-1_CP 9/2 (WirelessHART®)¹.

2 Normative references

The following documents, in whole or in part, are normatively referenced in this document and are indispensable for its application. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

IEC 62541-100, *OPC unified architecture – Part 100: Device Interface*

IEC 62769-4:2015, *Field Device Integration (FDI) – Part 4: FDI Packages*

NOTE IEC 62769-4 is technically identical to FDI-2024.

IEC 62769-5, *Field Device Integration (FDI) – Part 5: FDI Information Model*

NOTE IEC 62769-5 is technically identical to FDI-2025.

IEC 62769-7, *Field Device Integration (FDI) – Part 7: Communication Devices*

NOTE IEC 62769-7 is technically identical to FDI-2027.

3 Terms, definitions, abbreviated terms and acronyms

3.1 Terms and definitions

For the purposes of this document, the terms and definitions given in IEC 62541-100, IEC 62769-4, IEC 62769-5 and IEC 62769-7 apply.

3.2 Abbreviated terms and acronyms

For the purposes of this document, the following abbreviations apply:

CP	Communication profile (see IEC 61784-1 or IEC 61784-2)
CPF	Communication profile family (see IEC 61784-1 or IEC 61784-2)
EDD	Electronic Device Description (see IEC 61804)
EDDL	Electronic Device Description Language (see IEC 61804)
FDI	Field Device Integration

¹ HART and WirelessHART are the trade names of the non-profit consortium HART Communication Foundation, Austin, Texas, USA. This information is given for the convenience of users of this document and does not constitute an endorsement by IEC of the trademark holder or any of its products. Compliance does not require use of the trade names. Use of the trade names requires permission of the trade name holder.